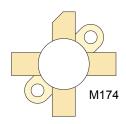
VRF151

50V, 150W, 175MHz

RF POWER VERTICAL MOSFET

The VRF151 is a gold-metallized silicon n-channel RF power transistor designed for broadband commercial and military applications requiring high power and gain without compromising reliability, ruggedness, or inter-modulation distortion.



FEATURES

- Improved Ruggedness $V_{(BR)DSS} = 170V$
- 150W with 22dB Typical Gain @ 30MHz, 50V
- 150W with 14dB Typical Gain @ 175MHz, 50V
- Excellent Stability & Low IMD
- · Common Source Configuration
- Available in Matched Pairs

- 70:1 Load VSWR Capability at Specified Operating Conditions
- Nitride Passivated
- · Refractory Gold Metallization
- High Voltage Replacement for MRF151
- RoHS Compliant



All Ratings: T_c =25°C unless otherwise specified **Maximum Ratings**

Symbol	Parameter	VRF151(MP)	Unit	
$V_{\scriptscriptstyle DSS}$	Drain-Source Voltage	170	V	
I _D	Continuous Drain Current @ T _C = 25°C	16	Α	
V_{GS}	Gate-Source Voltage	±40	V	
P _D	Total Device dissipation @ T _C = 25°C	300	W	
T _{STG}	Storage Temperature Range	-65 to 150	°C	
T_{J}	Operating Junction Temperature	200		

Static Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 100mA)	170	180		V
$V_{DS(ON)}$	On State Drain Voltage (I _{D(ON)} = 10A, V _{GS} = 10V)		2.0	3.0	l v
I _{DSS}	Zero Gate Voltage Drain Current (V _{DS} = 100V, V _{GS} = 0V)			1	mA
I _{GSS}	Gate-Source Leakage Current (V _{GS} = ±20V, V _{DS} = 0V)			1.0	μA
g _{fs}	Forward Transconductance (V _{DS} = 10V, I _D = 5A)	5.0			mhos
$V_{\rm GS(TH)}$	Gate Threshold Voltage (V _{DS} = 10V, I _D = 100mA)	2.9	3.6	4.4	V

Thermal Characteristics

Symbol	Characteristic	Min	Тур	Max	Unit
$R_{ heta JC}$	Junction to Case Thermal Resistance			0.60	°C/W

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

Microsemi Website - http://www.microsemi.com

Dynamic Characteristics

VRF	151	(MP)
		$\overline{}$

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ISS}	Input Capacitance	V _{GS} = 0V		375		
C _{oss}	Output Capacitance	V _{DS} = 150V		200		pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		12		

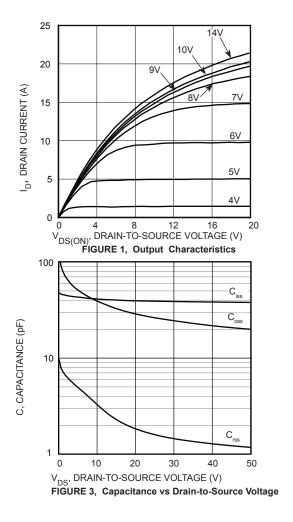
Functional Characteristics

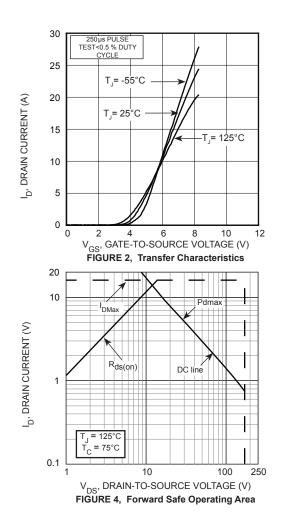
Symbol	Parameter	Min	Тур	Max	Unit
G _{PS}	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}^{-1}$	18	22		dB
G _{PS}	$f = 175MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W$		14		иь
$\eta_{\scriptscriptstyle D}$	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP 1}$		50		%
IMD _(d3)	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}^{-1}$		-30		dBc
Ψ	f_1 = 50MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W CW 70:1 VSWR - All Phase Angles , 0.2mSec X 20% Duty Factor	No Degradation in Output Power		Power	

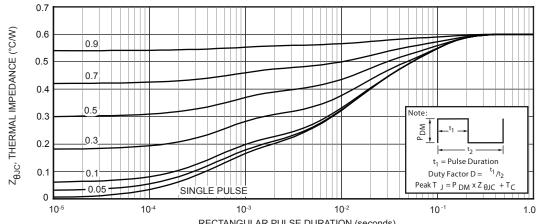
^{1.} To MIL-STD-1311 Version A, test method 2204B, Two Tone, Reference Each Tone

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

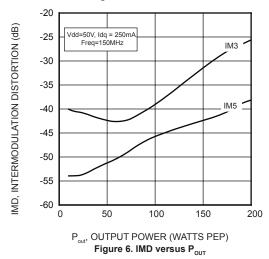
Typical Performance Curves

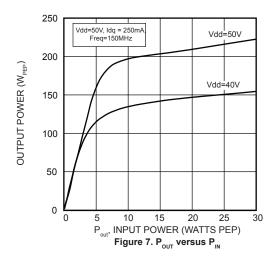




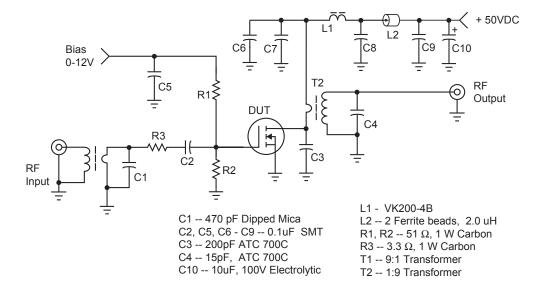


RECTANGULAR PULSE DURATION (seconds)
Figure 5. Maximum Effective Transient Thermal Impedance Junction-to-Case vs Pulse Duration

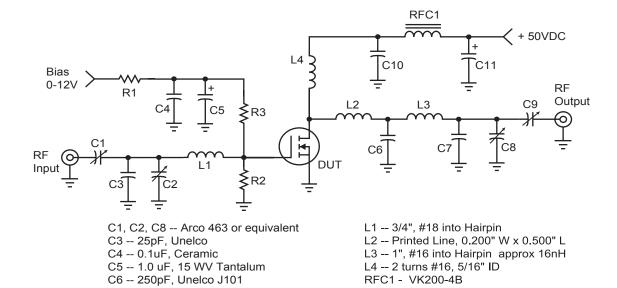




30 MHz test Circuit



175 MHz test Circuit



R1 – 150 Ω, 1/2W Carbon

 $R2 - 10k \Omega$, 1/2W Carbon

R3 - 120 Ω, 1/2W Carbon

C7-- 25pF, Unelco J101

C10 -- 0.05uF, Ceramic

C9 -- Arco 262 or equivalent

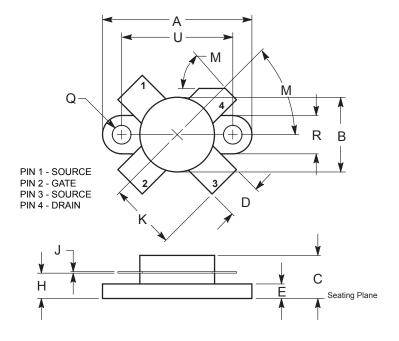
C11 -- 15uF, 60WV Electrolytic

Adding MP at the end of P/N specifies a matched pair where $V_{\text{GS(TH)}}$ is matched between the two parts. V_{TH} values are marked on the devices per the following table.

Code	Vth Range	Code 2	Vth Range
А	2.900 - 2.975	М	3.650 - 3.725
В	2.975 - 3.050	N	3.725 - 3.800
С	3.050 - 3.125	Р	3.800 - 3.875
D	3.125 - 3.200	R	3.875 - 3.950
E	3.200 - 3.275	S	3.950 - 4.025
F	3.275 - 3.350	Т	4.025 - 4.100
G	3.350 - 3.425	W	4.100 - 4.175
Н	3.425 - 3.500	Х	4.175 - 4.250
J	3.500 - 3.575	Υ	4.250 - 4.325
K	3.575 - 3.650	Z	4.325 - 4.400

 $[{]m V}_{_{
m TH}}$ values are based on Microsemi measurements at datasheet conditions with an accuracy of 1.0%.

.5" SOE Package Outline All Dimensions are ± .005



DIM	INCHES		MILLIMETERS	
DIIVI	MIN	MAX	MIN	MAX
Α	0.096	0.990	24.39	25.14
В	0.465	0.510	11.82	12.95
С	0.229	0.275	5.82	6.98
D	0.216	0.235	5.49	5.96
E	0.084	0.110	2.14	2.79
Н	0.144	0.178	3.66	4.52
J	0.003	0.007	0.08	0.17
K	0.435		11.0	
М	45° l	MON	45° l	MON
Q	0.115	0.130	2.93	3.30
R	0.246	0.255	6.25	6.47
U	0.720	0.730	18.29	18.54

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